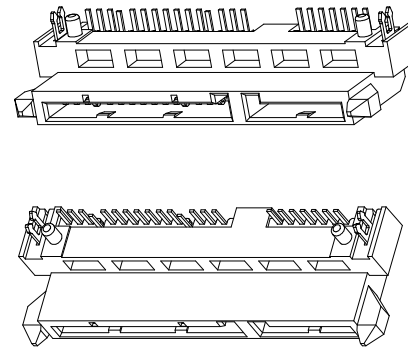
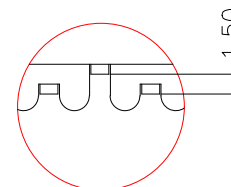
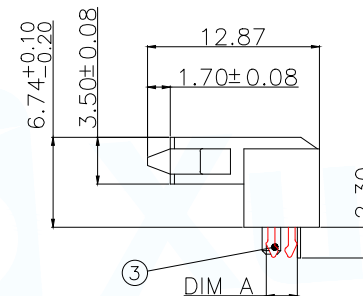
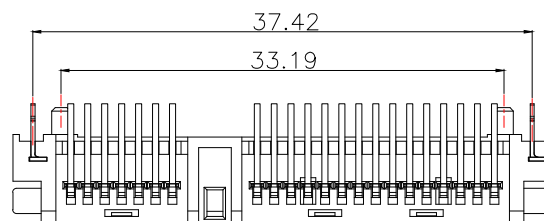




1.MATERIAL:
HOUSING: LCP UL 94V-0
COLOR:BLACK
CONTACT: PHOSPHOR BRONZE C5191R-H, T=0.25mm
PEG: BRASS C2680R-H, T=0.30mm
2.FINISH:
CONTACT:1u"/3u"/5u"/15u" GOLD PLATING ON CONTACT AREA
100u" TIN PLATING ON SOLDER TAILS
30u" NICKEL UNDERPLATING OVER ALL
PEG:100u" TIN PLATING ON SOLDER TAILS
30u" NICKEL UNDERPLATING OVER ALL



Technical drawing of a PCB layout for a 1.2mm thick board. The drawing shows a top view with dimensions in millimeters. Key features include a central rectangular area with a width of 37.42 ± 0.10 mm and a length of 33.19 ± 0.05 mm. The board has a thickness of 1.27 mm. The drawing includes various fillet radii (R0.50 TYP, R0.90 TYP) and hole diameters ($\varnothing 1.60 \pm 0.03$, $\varnothing 0.75$). The drawing is labeled "RECOMMEND P.C.B LAYOUT (T=1.2)".



ITEM	DIM A
SATA-03M-22AWZ-C21	2.10
SATA-03M-22AWZ-C23	2.30
SATA-03M-22AWZ-C245	2.45
SATA-03M-22AWZ-C259	2.59

环保要求		产品必须符合ROHS要求			
3	Peg	Brass C2680		Tin/Ni Plated	
2	Terminal	Pho.Bronze C5191R-H		Gold/Tin Plated	
1	Housing	High Temp	Black	UL 94V-0	
NO.	DESCRIPTION	MATERIAL	COLOR	REMARK	
MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:SATA 7+15P插座 板下6.74 DIP90°		
			PAR	SATA-03M-22AWZ-CN	
DWN	Lucas				
CHKD	Ethan				
APVD	Jacob				
SCALE1:1	UNIT:MM				
.X:±0.30	.X°:±3°	CUSTOMER COPY	SIZE:A4	SHEET:1F1	REV:A
.XX:±0.20	.XX°:±2°				
.XXX:±0.05	.XXX°:±0.5°				